ТО

Applicable	e standard									
	Operating		-35 °C to +85 °C (Note1) Stora			•		-10 °C to +60 °C(Note3)		
Rating	temperature range Operating		(,		Storage	emperature range torage		-10 °C to +60 °C (Note3) 40% to 70% (Note3)		
	humidity range		hu		humidity ra	numidity range		40% to 70% (NOTES)		
	Voltage		250 V AC		Applicable	connect	or	DF1E-*S-2. 5C		
	Current		AWG20 to 24: 3A AWG26: 2A AWG28: 1A AWG30: 0.5A			Voltage	oltage AC 3			
					UL, CSA			AWG20 to 22: 3/	١	
					,	Current		AWG24 to 28: 1A AWG30: 0.5A		
			Spe	ecificati	ons					
lt	em		Test method				Req	uirements	QT	АТ
Construc		_								
General exar	mination	Visually and by measuring instrument. According to drawing.						X	Х	
Marking			d visually.						X	X
	haracteris									
Contact resistate level method.	ince millivolt	20 mV MAX, 1 mA(DC or 1000 Hz).			30 r	30 mΩ MAX.				_
Insulation res	sistance	500 V DC.			100	1000 MΩ MIN.				
Voltage proo	f	650 V A	650 V AC for 1 min.			No flashover or breakdown.				_
Total go process			50 V AC for 1 min.			No hashover of breakdown.				_
	al charac									
Mechanical o	peration	50times i	50times insertions and extractions.			 Contact resistance: 30 mΩ MAX. No damage, crack or looseness of parts. 				
Vibration		Frequency 10 to 55 Hz, single amplitude				(2) No damage, crack or looseness of parts. χ (1) No electrical discontinuity of 1 μs. (2) No damage, crack or looseness of parts. X				_
Shock			0.75 mm, at 2 h, for 3 directions.			② No damage, crack or looseness of parts.				_
		directions	490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.							_
Environm	ental cha									
Rapid chang	e of						① Contact resistance: 30 mΩ MAX.			
temperature			Time $30 \rightarrow 5 \text{ max} \rightarrow 30 \rightarrow 5 \text{ max}$ min Under 5 cycles.			② Insulation resistance: 1000 MΩ MIN.③No damage, crack or looseness of parts.				_
Damp heat (Steady state)		Exposed	Exposed at 40 ± 2 °c, 90 to 95 %, 96 h.			① Contact resistance: 30 mΩ MAX.				
						② Insulation resistance: 500 MΩ MIN.③No damage, crack or looseness of parts.				-
Resistance to soldering		1) Automatic soldering (flow)				No deformation of case of excessive				
heat		Solder temperature, 260 °C for			loos	looseness of the terminals.				-
		Immersion,duration, 10 sec. 2) Manual soldering Soldering iron temperature: 300 °C,								
			ing time : 3 sec.	Ο,						
		No stre	ength on contact.							
Solderability			Soldered at solder temperature, 235 °c for insertion duration, 5 s.			Solder shall cover a minimum of 95 % of the surface being immersed.				
Remarks		200 0101	instruori duration, 5 S.		ဗ၁ 🤊	o or trie S	unace (being ininierseu.	Х	
Note1: Include	the temperature	e rising by cu	rrent.							
Note2:No cond Note3:Apply to	-	f long term st	torage for unused products before	re nch on hoa	ırd					
		-	re and humidity range is applied	-		g transport	ation.			
Count	i	Descript	ion of revisions		Designed	ned		Checked	Da	ite
⚠										
						Арр	roved	KI. AKIYAMA	15.0	6. 16
						Checked		KI. AKIYAMA	15. 06. 1	
						Designed		TS. KUMAZAWA	15. 06. 1	
Unless otherwise specified, refer to IEC 60512.						Drawn		MI. SAKIMURA 15. 06.		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					Drav	Drawing no. ELC-336779			6-00)
HS.		Specification sheet F			Part no.	no. DF1EG-*P-2. 5DSA (36)		
		Hirose	electric co., ltd.	Itd. Code		e no.		CL541 Z		1/1
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